

LNPTM STAT-KONTM COMPOUND RE007

RC-1007

Industrial

DESCRIPTION

LNP STAT-KON RE007 compound is based on Nylon 6/6 resin containing 35% carbon fiber. Added features of this grade include: Electrically Conductive.

GENERAL INFORMATION	
Features	Electrically Conductive, Carbon fiber filled, High stiffness/Strength, No PFAS intentionally added
Fillers	Carbon Fiber
Polymer Types	Polyamide 66 (Nylon 66)
Processing Techniques	Injection Molding
INDUSTRY	SUB INDUSTRY
Electrical and Electronics	Electronic Components

Material Handling

TYPICAL PROPERTY VALUES

Revision 20231109

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
MECHANICAL (1)			
Tensile Stress, brk, Type I, 5 mm/min	275	MPa	ASTM D638
Tensile Strain, brk, Type I, 5 mm/min	1.7	%	ASTM D638
Tensile Modulus, 5 mm/min	29920	MPa	ASTM D638
Flexural Stress, brk, 1.3 mm/min, 50 mm span	387	MPa	ASTM D790
Flexural Modulus, 1.3 mm/min, 50 mm span	24300	MPa	ASTM D790
Tensile Stress, break, 5 mm/min	282	MPa	ISO 527
Tensile Strain, break, 5 mm/min	1.7	%	ISO 527
Tensile Modulus, 1 mm/min	30410	MPa	ISO 527
Flexural Stress	391	MPa	ISO 178
Flexural Modulus, 2 mm/min	24610	MPa	ISO 178
IMPACT (1)			
Izod Impact, unnotched, 23°C	1030	J/m	ASTM D4812
Izod Impact, notched, 23°C	103	J/m	ASTM D256
Multiaxial Impact	3	J	ISO 6603
Instrumented Dart Impact Total Energy, 23°C	7	J	ASTM D3763
Izod Impact, unnotched 80*10*4 +23°C	62	kJ/m²	ISO 180/1U
Izod Impact, notched 80*10*4 +23°C	8	kJ/m²	ISO 180/1A
THERMAL (1)			
HDT, 0.45 MPa, 3.2 mm, unannealed	263	°C	ASTM D648
HDT, 1.82 MPa, 3.2mm, unannealed	257	°C	ASTM D648
CTE, -30°C to 30°C, flow	2.4E-05	1/°C	ASTM D696
CTE, -30°C to 30°C, xflow	3.7E-05	1/°C	ASTM D696
HDT/Bf, 0.45 MPa Flatw 80*10*4 sp=64mm	262	°C	ISO 75/Bf
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PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
HDT/Af, 1.8 MPa Flatw 80*10*4 sp=64mm	256	°C	ISO 75/Af
PHYSICAL (1)			
Specific Gravity	1.33	-	ASTM D792
Density	1.322	g/cm³	ASTM D792
Moisture Absorption, (23°C/50% RH/24 hrs)	0.59	%	ASTM D570
Mold Shrinkage, flow, 24 hrs ⁽²⁾	0.2 – 0.4	%	ASTM D955
Mold Shrinkage, xflow, 24 hrs ⁽²⁾	0.9 – 1.1	%	ASTM D955
Moisture Absorption (23°C / 50% RH)	0.92	%	ISO 62
ELECTRICAL (1)			
Surface Resistivity (3)	1.E+02 – 1.E+05	Ω	ASTM D257
INJECTION MOLDING (4)			
Drying Temperature	80	°C	
Drying Time	4	Hrs	
Maximum Moisture Content	0.15 – 0.25	%	
Melt Temperature	280 – 305	°C	
Front - Zone 3 Temperature	295 – 305	°C	
Middle - Zone 2 Temperature	280 – 295	°C	
Rear - Zone 1 Temperature	265 – 275	°C	
Mold Temperature	95 – 110	°C	
Back Pressure	0.2 – 0.3	MPa	
Screw Speed	30 – 60	rpm	

- (1) The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design.
- (2) Measurements made from laboratory test coupon. Actual shrinkage may vary outside of range due to differences in processing conditions, equipment, part geometry and tool design. It is recommended that mold shrinkage studies be performed with surrogate or legacy tooling prior to cutting tools for new molded article.
- (3) Measurement meets requirements as specified in ASTM D4496.
- (4) Injection Molding parameters are only mentioned as general guidelines. These may not apply or may need adjustment in specific situations such as low shot sizes, large part molding, thin wall molding and gas-assist molding.

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